TOSHIBA Bi-CMOS Integrated Circuit Silicon Monolithic

TB62726ANG, TB62726AFG

16-bit Constant-Current LED Driver with Operating Voltage of 3.3-V and 5-V

0.4 V (output current 2 to 40 mA)

The TB62726A series are comprised of constant-current drivers designed for LEDs and LED displays. The output current value can be set using an external resistor.

As a result, all outputs will have virtually the same current levels.

This driver incorporates 16-bit constant-current outputs, a

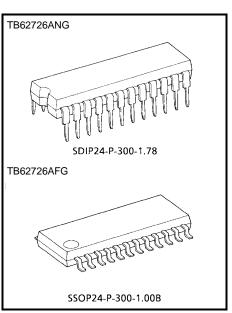
16-bit shift register, a 16-bit latch and a 16-bit AND-gate circuit. These drivers have been designed using the Bi-CMOS process.

This devices are a product for the Pb free.

Features

- Output current capability and number of outputs: 90 mA \times 16 outputs
- Constant current range: 2 to 90 mA
- Application output voltage: 0.7 V (output current 2 to 80 mA)
- For anode-common LEDs
- Input signal voltage level: 3.3-V and 5-V CMOS level (Schmitt trigger input)
- Power supply voltage range VDD = 3.0 to 5.5 V
- Maximum output terminal voltage: 17 V
- Serial and parallel data transfer rate: 20 MHz (max, cascade connection)
- Operating temperature range $T_{opr} = -40$ to $85^{\circ}C$
- Package: Type ANG: SDIP24-P-300-1.78 Type AFG: SSOP24-P-300-1.00B
- Current accuracy (All output ON)

| Output Voltage | Current / | Output Current | |
|----------------|--------------|----------------|----------------|
| | Between Bits | Between ICs | Output Current |
| \geq 0.4 V | ±4% | ±15% | 2 to 5 mA |
| ≧ 0.7 V | 1478 | ±12% | 5 to 80 mA |



Weight SDIP24-P-300-1.78: 1.22 g (typ.) SSOP24-P-300-1.00B: 0.32 g (typ.)

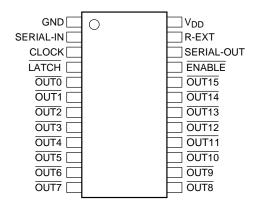
Company Headquarters 3 Northway Lane North Latham, New York 12110 Toll Free: 800.984.5337 Fax: 518.785.4725



Web: www.marktechopto.com | Email: info@marktechopto.com

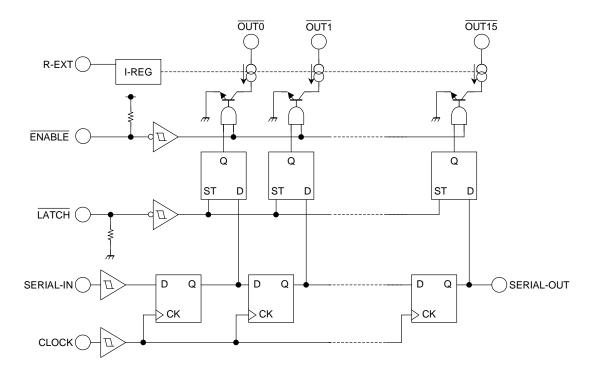
California Sales Office: 950 South Coast Drive, Suite 225 Costa Mesa, California 92626 Toll Free: 800.984.5337 Fax: 714.850.9314

Pin Assignment (top view)



Warnings: Short-circuiting an output terminal to GND or to the power supply terminal may broken the device. Please take care when wiring the output terminals, the power supply terminal and the GND terminals.

Block Diagram



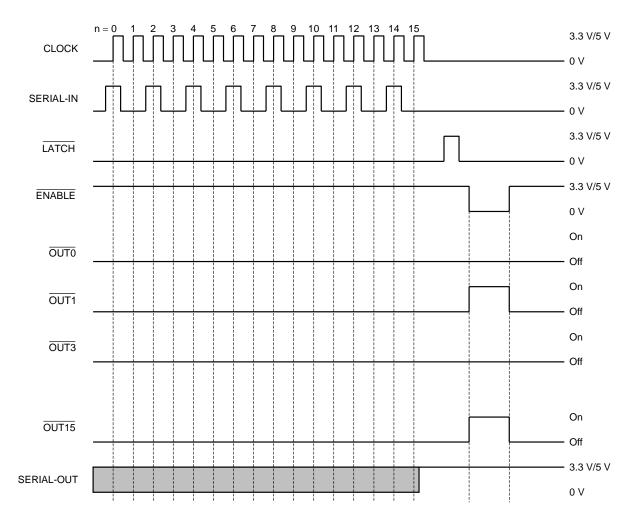
Truth Table

| CLOCK | LATCH | ENABLE | SERIAL-IN | OUT0 ··· OUT7 ··· OUT15 | SERIAL-OUT |
|-------|-------|--------|-----------|---------------------------|------------|
| | Н | L | Dn | Dn … Dn – 7 … Dn – 15 | Dn – 15 |
| | L | L | Dn + 1 | No change | Dn – 14 |
| | н | L | Dn + 2 | Dn + 2 … Dn - 5 … Dn - 13 | Dn – 13 |
| | х | L | Dn + 3 | Dn + 2 … Dn - 5 … Dn - 13 | Dn – 13 |
| | Х | Н | Dn + 3 | OFF | Dn – 13 |

Note 1: $\overline{OUT0}$ to $\overline{OUT15}$ = On when Dn = H; $\overline{OUT0}$ to $\overline{OUT15}$ = Off when Dn = L. In order to ensure that the level of the power supply voltage is correct, an external resistor must be connected between R-EXT and GND.

<u>TOSHIBA</u>

Timing Diagram



Warning: Latch circuit is leveled-latch circuit. Be careful because it is not triggered-latch circuit.

Note 2: The latches circuit holds data by pulling the LATCH terminal Low.

And, when **LATCH** terminal is a High level, latch circuit doesn't hold data, and it passes from the input to the output.

When $\overline{\text{ENABLE}}$ terminal is a Low level, output terminal $\overline{\text{OUT0}}$ to $\overline{\text{OUT15}}$ respond to the data, and on and off does.

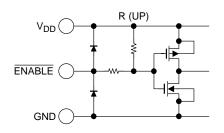
And, when ENABLE terminal is a High level, it offs with the output terminal regardless of the data.

Terminal Description

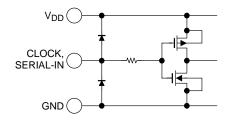
| Pin No. | Pin Name | Function |
|---------|-----------------|---|
| 1 | GND | GND terminal for control logic |
| 2 | SERIAL-IN | Input terminal for serial data for data shift register |
| 3 | CLOCK | Input terminal for clock for data shift on rising edge |
| 4 | LATCH | Input terminal for data strobe When the LATCH input is driven High, data is not latched. When it is pulled Low, data is latched. |
| 5 to 20 | OUT0 to OUT15 | Constant-current output terminals |
| 21 | ENABLE | Input terminal for output enable. All outputs ($\overline{OUT0}$ to $\overline{OUT15}$) are turned off, when the \overline{ENABLE} terminal is driven High. And are turned on, when the terminal is driven Low. |
| 22 | SERIAL-OUT | Output terminal for serial data input on SERIAL-IN terminal |
| 23 | R-EXT | Input terminal used to connect an external resistor. This regulated the output current. |
| 24 | V _{DD} | 3.3-V/5-V supply voltage terminal |

Equivalent Circuits for Inputs and Outputs

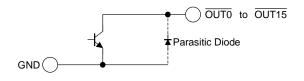
1. ENABLE terminal



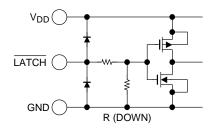
3. CLOCK, SERIAL-IN terminal



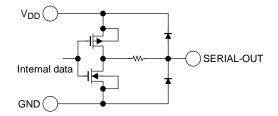
5. $\overline{\text{OUT0}}$ to $\overline{\text{OUT15}}$ terminals



2. LATCH terminal



4. SERIAL-OUT terminal



4

Maximum Ratings (T_{opr} = 25°C)

| Characteristics | | Symbol | Rating | Unit |
|-----------------------|--------------------------------|--------------------------|-------------------------------|-------|
| Supply voltage | | V _{DD} | 6 | V |
| Input voltage | | V _{IN} | -0.2 to V _{DD} + 0.2 | V |
| Output current | | I _{OUT} | +90 | mA/ch |
| Output voltage | | V _{OUT} | -0.2 to 17 | V |
| | ANG-type (when not mounted) | P _{d1} | 1.25 | |
| Power dissipation | ANG-type (on PCB) | | 1.78 | W |
| (Note 3) | AFG-type (when not mounted) | P _{d2} | 0.83 | vv |
| | AFG-type (on PCB) | | 1.00 | |
| | ANG-type (when not mounted) | R _{th (j} -a) 1 | 104 | |
| Thermal resistance | ANG-type (on PCB) | | 70 | °C/W |
| (Note 3) | AFG-type (when not mounted) | R _{th (j-a) 2} | 140 | -C/w |
| | AFG-type (on PCB) | | 120 | |
| Operating temperature | | T _{opr} | -40 to 85 | °C |
| Storage temperature | | T _{stg} | -55 to 150 | °C |

Note 3: ANG-Type: Powers dissipation is derated by 14.28 mW/°C if device is mounted on PCB and ambient temperature is above 25°C.

AFG-Type: Powers dissipation is derated by 6.67 mW/°C if device is mounted on PCB and ambient temperature is above 25°C.

With device mounted on glass-epoxy PCB of less than 40% Cu and of dimensions 50 mm \times 50 mm \times 1.6 mm.

Recommended Operating Conditions ($T_{opr} = -40^{\circ}C$ to 85°C unless otherwise specified)

| Characteristics | Symbol | Conditions | Min | Тур. | Max | Unit | |
|--------------------------------|-------------------|--------------------------------|--------------------------|------|---------------------------|-------|--|
| Supply voltage | V _{DD} | — | 3 | | 5.5 | V | |
| Output voltage | V _{OUT} | — | | 0.7 | 4 | V | |
| | IOUT | Each DC 1 circuit | 2 | _ | 80 | mA/ch | |
| Output current | I _{OH} | SERIAL-OUT | | _ | -1 | mA | |
| | I _{OL} | SERIAL-OUT | _ | _ | 1 | | |
| Input voltage | V _{IH} | | 0.7 × V _{DD} | _ | V _{DD} + 0.15 | v | |
| | V _{IL} | | -0.15 | _ | $0.3 \times V_{DD}$ | | |
| Clock frequency | fCLK | Cascade connected | | | 20 | MHz | |
| LATCH pulse width | t _{wLAT} | | 50 | | _ | ns | |
| CLOCK pulse width | t _{wCLK} | — | 25 | | _ | ns | |
| ENABLE pulse width | | Upper I _{OUT} = 20 mA | 2000 | | _ | ns | |
| (Note 4) | t _{wENA} | Lower I _{OUT} = 20 mA | 3000 | _ | _ | 115 | |
| Set-up time for CLOCK terminal | tSETUP1 | | 10 | | _ | ns | |
| Hold time for CLOCK terminal | tHOLD |] — | 10 | | _ | ns | |
| Set-up time for LATCH terminal | tSETUP2 | | 50 | | _ | ns | |

Note 4: When the pulse of the Low level is inputted to the ENABLE terminal held in the High level.

Electrical Characteristics ($T_{opr} = 25^{\circ}C$, $V_{DD} = 3.0$ V to 5.5 V unless otherwise specified)

| Characteristics | Symbol | Conditions | | Min | Тур. | Max | Unit |
|--|------------------------|--|----------------------------|--------|-------|------------------------|------|
| Supply voltage | V _{DD} | Normal operation | | 3.0 | _ | 5.5 | V |
| Output current | I _{OUT1} | $\begin{array}{l} V_{OUT}=0.4 \text{ V},\\ V_{DD}=3.3 \text{ V} \end{array}$ | - R _{EXT} = 490 Ω | 31.96 | 36.20 | 40.54 | - mA |
| | I _{OUT2} | $V_{OUT} = 0.4 \text{ V},$ $V_{DD} = 5 \text{ V}$ | | 31. 59 | 35.90 | 40.20 | |
| | I _{OUT3} | V _{OUT} = 0.7 V, V _{DD} = 3.3 V | R _{EXT} = 250 Ω | 63.63 | 72.30 | 80.97 | |
| | I _{OUT4} | $\begin{array}{l} V_{OUT}=0.7 \text{ V},\\ V_{DD}=5 \text{ V} \end{array}$ | NEXT - 200 32 | 62.75 | 71.30 | 79.95 | |
| Output current error between hits | ΔI_{OUT1} | $V_{OUT} \ge 0.4 \text{ V},$ All outputs ON | $R_{EXT} = 490 \ \Omega$ | | ±1 | ±4 | % |
| Output current error between bits | ΔI_{OUT2} | $V_{OUT} \ge 0.4 \text{ V},$ All outputs ON | $R_{EXT} = 250 \ \Omega$ | | ΞI | 14 | 76 |
| Output leakage current input voltage | I _{OZ} | V _{OUT} = 15.0 V | | _ | | 1 | μA |
| Input voltage | V _{IN} - | _ | 0.7 V _{DD} | | | V _{DD} | v |
| input voltage | | _ | | GND | — | 0.3 V _{DD} | v |
| | V _{OL} | $I_{OL} = 1.0 \text{ mA}, V_{DD} = 3$ | 8.3 V | — | — | 0.3 | |
| SOUT terminal voltage | VOL | $I_{OL}=1.0~mA,~V_{DD}=5~V$ | | — | | 0.3 | V |
| Soon terminal voltage | Vou | I_{OH} = $-$ 1.0 mA, V_{DD} = 3.3 V | | 3 | — | | |
| | VOH | V _{OH} I _{OH} = 1.0 mA, V _{DD} = 5 V | | 4.7 | — | | |
| Output current Supply voltage Regulation | %/V _{DD} | When V _{DD} is changed 3 V to 5.5 V | | _ | -1 | -5 | % |
| Pull-up resistor | R (Up) | ENABLE terminal | | - 115 | 230 | 460 | kΩ |
| Pull-down resistor | R (Down) | LATCH terminal | | 110 | 230 | 400 | KS 2 |
| | IDD (OFF) 1 | V _{OUT} = 15.0 V | $R_{EXT} = OPEN$ | _ | 0.1 | 0.5 | |
| | IDD (OFF) 2 | V _{OUT} = 15.0 V, All outputs OFF | $R_{EXT} = 490 \ \Omega$ | 1 | 3.5 | 5 | |
| | IDD (OFF) 3 | V _{OUT} = 15.0 V, All outputs OFF | $R_{EXT} = 250 \ \Omega$ | 4 | 6 | 9 | |
| Supply current | IDD (ON) 1 | V _{OUT} = 0.7 V, All outputs ON | $R_{EXT} = 490 \ \Omega$ | _ | 9 | 15 | mA |
| | | Same as the above, T | $opr = -40^{\circ}C$ | _ | _ | 20 | |
| | I _{DD} (ON) 2 | V _{OUT} = 0.7 V, All outputs ON | $R_{EXT} = 250 \ \Omega$ | _ | 18 | 25 | |
| | | Same as the above, $T_{opr} = -40^{\circ}C$ | | _ | _ | 40 | |

| Characteristics | Symbol | Conditions | Min | Тур. | Max | Unit | |
|-------------------------|-------------------|---|-----|------|-----|------|--|
| | t _{pLH1} | $\frac{CLK-\overline{OUTn}}{\overline{ENABLE}} = "L"$ | | 150 | 300 | | |
| | t _{pLH2} | LATCH - OUTn , ENABLE = "L" | | 140 | 300 | | |
| | t _{pLH3} | ENABLE - OUTn , LATCH = "H" | | 140 | 300 | | |
| Propagation delay | t _{pLH} | CLK-SERIAL OUT | | 6 | | ns | |
| Propagation delay | t _{pHL1} | $\frac{CLK-\overline{OUTn}}{\overline{ENABLE}} = "L"$ | | 170 | 340 | 115 | |
| | t _{pHL2} | IATCH - OUTn , ENABLE = "L" | _ | 170 | 340 | | |
| | t _{pHL3} | ENABLE - OUTn , LATCH = "H" | | 170 | 340 | | |
| | t _{pLH} | CLK-SERIAL OUT | 4 | 7 | _ | | |
| Output rise time | t _{or} | 10 to 90% of voltage waveform | 40 | 85 | 150 | ns | |
| Output fall time | t _{of} | 90 to 10% of voltage waveform | 40 | 70 | 150 | ns | |
| Maximum CLOCK rise time | tr | When not on PCB | _ | _ | 5 | μS | |
| Maximum CLOCK fall time | t _f | (Note 5) | _ | _ | 5 | μS | |

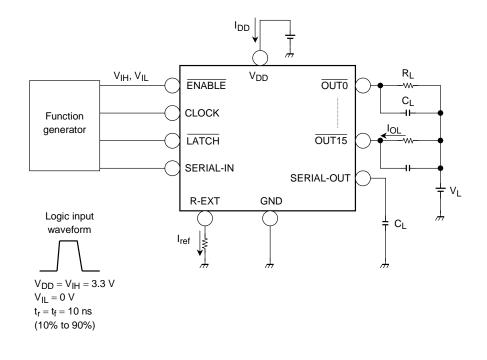
Switching Characteristics (T_{opr} = 25°C unless otherwise specifed)

Conditions: (Refer to test circuit.)

 T_{opr} = 25°C, V_{DD} = V_{IH} = 3.3 V and 5 V, V_{OUT} = 0.7 V, V_{IL} = 0 V, R_{EXT} = 490 Ω , V_L = 3.0 V, R_L = 60 Ω , C_L = 10.5 pF

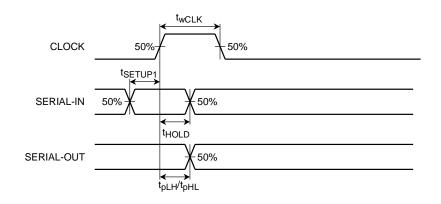
Note 5: If the device is connected in a cascade and t_r/t_f for the waveform is large, it may not be possible to achieve the timing required for data transfer. Please consider the timings carefully.

Test Circuit

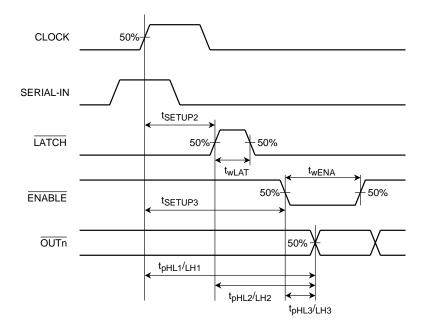


Timing Waveforms

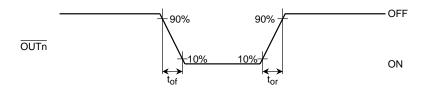
1. CLOCK, SERIAL-IN, SERIAL-OUT



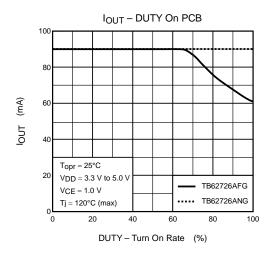
2. CLOCK, SERIAL-IN, LATCH, ENABLE, OUTn

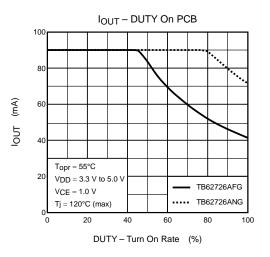


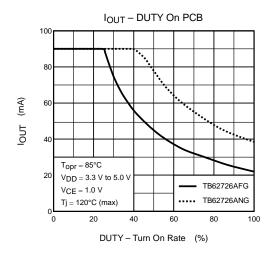
3. OUTn

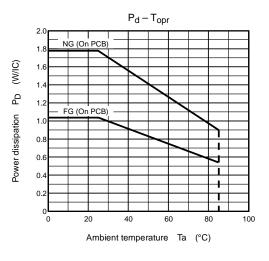


Output Current – Duty (LEDS turn-on rate)

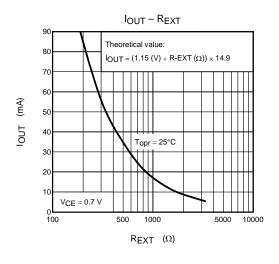








Output Current – R_{EXT} Resistor



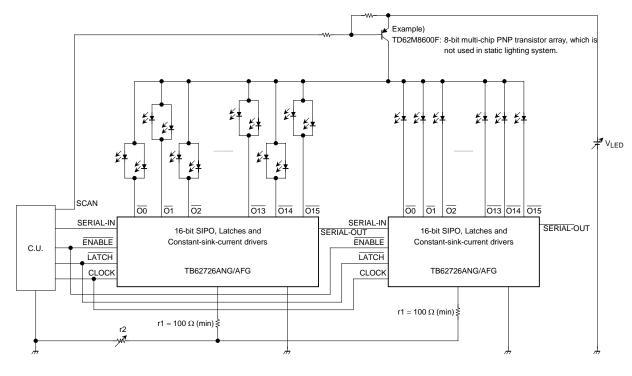
TB62726ANG/AFG

Application Circuit (example 1): The general composition in static lighting of LED.

More than VLED (V) \geq Vf (total max) + 0.7 is recommended with the following application circuit with the LED power supply VLED.

r1: The setup resistance for the setup of output current of every IC.

r
2: The variable resistance for the brightness control of every LED module.



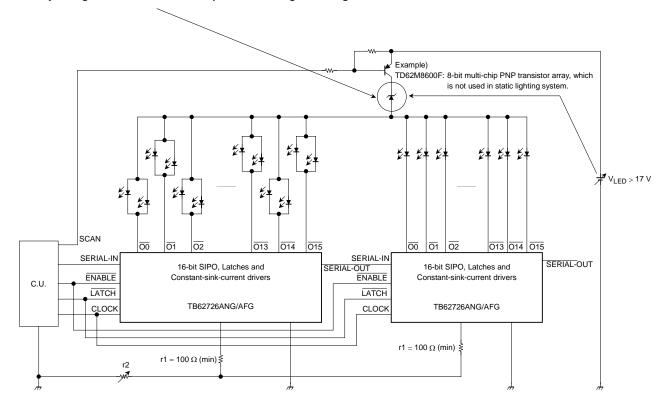
10

2005-12-21

TB62726ANG/AFG

Application Circuit (example 2): When the condition of VLED is VLED > 17 V

The unnecessary voltage is one effective technique as to making the voltage descend with the zenor diode.



11

2005-12-21

TB62726ANG/AFG

Application Circuit (example 3): When the condition of VLED is Vf +0.7 < VLED < 17 V

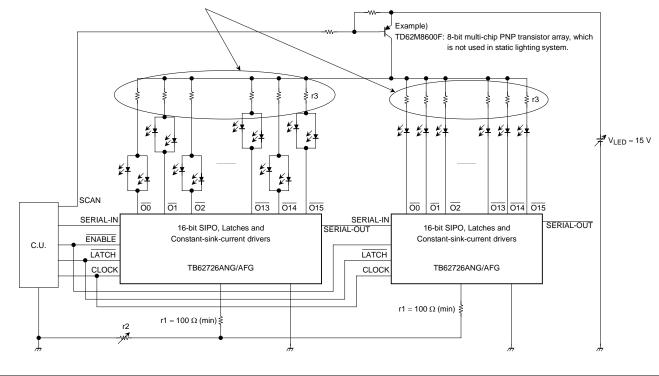
VOUT = VLED-Vf = 0.7 to 1.0 V is the most suitable for VOUT.

Surplus VOUT causes an IC fever and the useless consumption electric power.

It is the one way of being effective to build in the r3 in this problem.

r3 can make a calculation to the formula r3 Ω = surplus VOUT/IOUT.

Though the resistance parts increase, the fixed constant current performance is kept



12

2005-12-21

Notes

• Operation may become unstable due to the electromagnetic interference caused by the wiring and other phenomena.

To counter this, it is recommended that the IC be situated as close as possible to the LED module. If overvoltage is caused by inductance between the LED and the output terminals, both the LED and the terminals may suffer damage as a result.

• There is only one GND terminal on this device when the inductance in the GND line and the resistor are large, the device may malfunction due to the GND noise when output switchings by the circuit board pattern and wiring.

To achieve stable operation, it is necessary to connect a resistor between the REXT terminal and the GND line. Fluctuation in the output waveform is likely to occur when the GND line is unstable or when a capacitor (of more than 50 pF) is used.

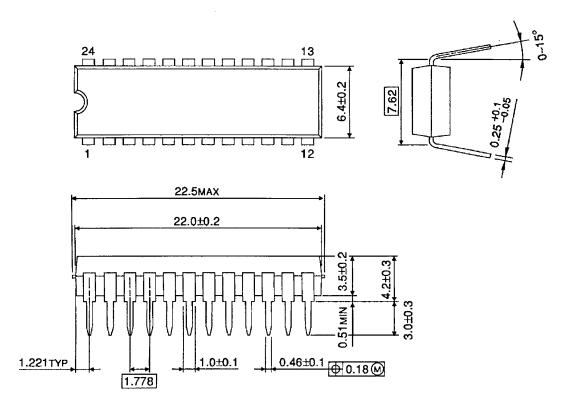
Therefore, take care when designing the circuit board pattern layout and the wiring from the controller.

- This application circuit is a reference example and is not guaranteed to work in all conditions. Be sure to check the operation of your circuits.
- This device does not include protection circuits for overvoltage, overcurrent or overtemperature. If protection is necessary, it must be incorporated into the control circuitry.
- The device is likely to be destroyed if a short-circuit occurs between either of the power supply pins and any of the output terminals when designing circuits, pay special attention to the positions of the output terminals and the power supply terminals (VDD and VLED), and to the design of the GND line.

Package Dimensions

SDIP24-P-300-1.78

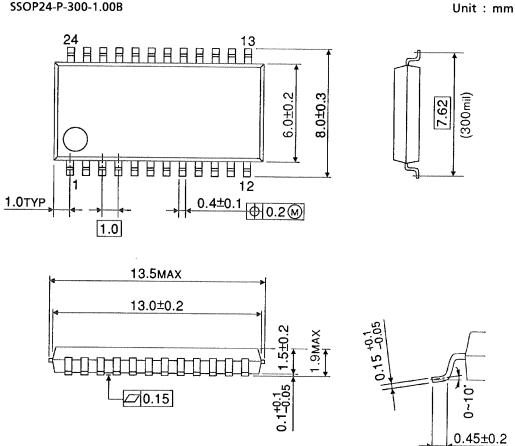
Unit : mm



Weight: 1.22 g (typ.)

Package Dimensions

SSOP24-P-300-1.00B



Weight: 0.32 g (typ.)

Notes on Contents

1. Block Diagrams

Some functional blocks, circuits, or constants may be omitted or simplified in the block diagram for explanatory purposes.

2. Maximum Ratings

The absolute maximum ratings of a semiconductor device are a set of specified parameter values that must not be exceeded during operation, even for an instant.

If any of these ratings are exceeded during operation, the electrical characteristics of the device may be irreparably altered and the reliability and lifetime of the device can no longer be guaranteed.

Moreover, any exceeding of the ratings during operation may cause breakdown, damage and/or degradation in other equipment. Applications using the device should be designed so that no maximum rating will ever be exceeded under any operating conditions.

Before using, creating and/or producing designs, refer to and comply with the precautions and conditions set forth in this document.

3. Recommended operating conditions

The values of the conditions are applied within the range of the operating temperature and not guaranteed.

4. Test Circuits

Components in test circuits are used only to obtain and confirm device characteristics. These components and circuits are not guaranteed to prevent malfunction or failure in application equipment.

5. Graphics characteristics

Graphics characteristics are reference ones and not guaranteed.

6. Timing Charts

Timing charts may be simplified for explanatory purposes.

7. Equivalent Circuits

The equivalent circuit diagrams may be simplified or some parts of them may be omitted for explanatory purposes.

8. Application Circuits

The application circuits shown in this document are provided for reference purposes only. Thorough evaluation is required, especially in the phase of mass production design.

In furnishing these examples of application circuits, Toshiba does not grant the use of any industrial property rights.

Handling of the IC

Ensure that the product is installed correctly to prevent breakdown, damage and/or degradation in the product or equipment.

About solderability, following conditions were confirmed

Solderability

- (1) Use of Sn-37Pb solder Bath
 - solder bath temperature = 230°C
 - · dipping time = 5 seconds
 - \cdot the number of times = once
 - · use of R-type flux
- (2) Use of Sn-3.0Ag-0.5Cu solder Bath
 - · solder bath temperature = $245^{\circ}C$
 - dipping time = 5 seconds
 - \cdot the number of times = once
 - use of R-type flux

RESTRICTIONS ON PRODUCT USE

030619EBA

- The information contained herein is subject to change without notice.
- The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by TOSHIBA for any infringements of patents or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of TOSHIBA or others.
- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property.

In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc..

- The TOSHIBA products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.). These TOSHIBA products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury ("Unintended Usage"). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, medical instruments, all types of safety devices, etc.. Unintended Usage of TOSHIBA products listed in this document shall be made at the customer's own risk.
- The products described in this document are subject to the foreign exchange and foreign trade laws.
- TOSHIBA products should not be embedded to the downstream products which are prohibited to be produced and sold, under any law and regulations.